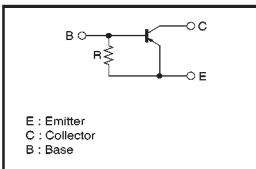


Digital transistors (built-in resistor)

DTA124GKA / DTA124GSA

●Features

- The built-in bias resistors consist of thin-film resistors with complete isolation to allow positive biasing of the input, and parasitic effects are almost completely eliminated.
- Only the on / off conditions need to be set for operation, making device design easy.
- Higher mounting densities can be achieved.

●Circuit schematic**●Electrical characteristics (Ta=25°C)**

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Collector-base breakdown voltage	BV _{CBO}	-50	—	—	V	I _C =-50 μA
Collector-emitter breakdown voltage	BV _{CEO}	-50	—	—	V	I _E =-1mA
Emitter-base breakdown voltage	BV _{EBO}	-5	—	—	V	I _E =-330 μA
Collector cutoff current	I _{CEO}	—	—	-0.5	μA	V _{CB} =-50V
Emitter cutoff current	I _{EBO}	-140	—	-260	μA	V _{EB} =-4V
Collector-emitter saturation voltage	V _{CES(sat)}	—	—	0.3	V	I _C =-10mA, I _E =-0.5mA
DC current transfer ratio	h _{FE}	56	—	—	—	I _C =-5mA, V _{CE} =-5V
Emitter-base resistance	R	15.4	22	28.6	kΩ	—
Transition frequency	f _T	—	250	—	MHz	V _{CE} =-10V, I _E =5mA, f=100MHz

* Transition frequency of the device.

(94-543-A124G)

●Absolute maximum ratings (Ta=25°C)

Parameter	Symbol	Limits	Unit
Collector-base voltage	V _{CBO}	-50	V
Collector-emitter voltage	V _{CEO}	-50	V
Emitter-base voltage	V _{EBO}	-5	V
Collector current	I _C	-100	mA
Collector power dissipation	DTC124GKA DTA124GSA	P _C 200 300	mW
Junction temperature	T _J	150	°C
Storage temperature	T _{STG}	-55~+150	°C

●Package, marking, and packaging specifications

Part No.	DTA124GKA	DTA124GSA
Package	SMT3	SPT
Marking	K15	—
Packaging code	T146	TP
Basic ordering unit (pieces)	3000	5000

* Transition frequency of the device.

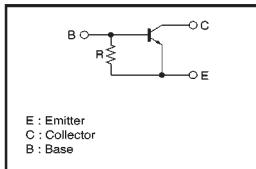
(94-543-A124G)

Digital transistors (built-in resistor)

DTC124GUA / DTC124GKA / DTC124GSA

●Features

- The built-in bias resistors consist of thin-film resistors with complete isolation to allow positive biasing of the input, and parasitic effects are almost completely eliminated.
- Only the on / off conditions need to be set for operation, making device design easy.
- Higher mounting densities can be achieved.

●Circuit schematic**●Electrical characteristics (Ta=25°C)**

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Collector-base breakdown voltage	BV _{CBO}	50	—	—	V	I _C =50 μA
Collector-emitter breakdown voltage	BV _{CEO}	50	—	—	V	I _E =1mA
Emitter-base breakdown voltage	BV _{EBO}	5	—	—	V	I _E =330 μA
Collector cutoff current	I _{CEO}	—	—	0.5	μA	V _{CB} =50V
Emitter cutoff current	I _{EBO}	140	—	260	μA	V _{EB} =4V
Collector-emitter saturation voltage	V _{CES(sat)}	—	—	0.3	V	I _C =10mA, I _E =0.5mA
DC current transfer ratio	h _{FE}	56	—	—	—	I _C =5mA, V _{CE} =5V
Emitter-base resistance	R	15.4	22	28.6	kΩ	—
Transition frequency	f _T	—	250	—	MHz	V _{CE} =10V, I _E =-5mA, f=100MHz

* Transition frequency of the device.

●Absolute maximum ratings (Ta=25°C)

Parameter	Symbol	Limits	Unit
Collector-base voltage	V _{CBO}	50	V
Collector-emitter voltage	V _{CEO}	50	V
Emitter-base voltage	V _{EBO}	5	V
Collector current	I _C	100	mA
Collector power dissipation	DTC124GUA/DTC124GKA DTC124GSA	P _C 200 300	mW
Junction temperature	T _J	150	°C
Storage temperature	T _{STG}	-55~+150	°C

●Package, marking, and packaging specifications

Part No.	DTC124GUA	DTC124GKA	DTC124GSA
Package	UMT3	SMT3	SPT
Marking	K25	K25	—
Packaging code	T106	T146	TP
Basic ordering unit (pieces)	3000	3000	5000

* Transition frequency of the device.

(94S-665-C124G)